



Click [here](#) for the 3D model.

General Information

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|--------------------------|--|
| Series | T521 |
| Dielectric | Polymer Tantalum |
| Style | SMD Chip |
| Description | SMD, Polymer, Molded, Low ESR, Non-Combustible |
| Features | Low ESR, High Voltage |
| RoHS | Yes |
| Termination | Tin |
| AEC-Q200 | No |
| Typical Component Weight | 274.3 mg |
| Shelf Life | 52 Weeks |
| MSL | 3 |

Specifications

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|-----------------------|---|
| Capacitance | 100 uF |
| Capacitance Tolerance | 20% |
| Voltage DC | 16 VDC (105C), 10.72 VDC (125C) |
| Temperature Range | -55/+125°C |
| Rated Temperature | 105°C |
| Life | 2000 Hrs (125C) |
| Humidity | 60C, 90% RH, 500 Hours, No Load |
| Dissipation Factor | 10% 120Hz 25C |
| Failure Rate | N/A |
| ESR | 50 mOhms (100kHz 25C) |
| Ripple Current | 2320 mA (rms, 100kHz 45/85C), 1624 mA (rms, 105C), 580 mA (rms, 125C) |
| Leakage Current | 80 uA (5min 25°C) |

Dimensions

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|-----------|----------------|
| Footprint | 7343 |
| L | 7.3mm +/-0.3mm |
| W | 4.3mm +/-0.3mm |
| H | 1.8mm +/-0.2mm |
| T | 0.13mm REF |
| S | 1.3mm +/-0.3mm |
| F | 2.4mm +/-0.1mm |
| A | 3.8mm MIN |
| X | 0.05mm REF |

Packaging Specifications

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|--------------------|------------|
| Packaging | T&R, 178mm |
| Packaging Quantity | 1000 |

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